

AT3216 Series Multilayer Chip Antenna

Features

- Monolithic SMD with small, low-profile and light-weight type.
- ❖ Wide bandwidth

Applications

- ❖Bluetooth/Wireless LAN/Home RF
- ❖ISM band 2.4GHz applications



Specifications

Part Number	Frequency Range (MHz)	Peak Gain (XZ-V)	Average Gain (XZ-V)	VSWR	Impedance	
AT3216 -B2R7HAA_	2400 ~ 2500	0.5 dBi typ.	-0.5 dBi typ.	2 max.	50 Ω	

Q'ty/Reel (pcs) : 3,000pcs
Operating Temperature Range : -40 ~ +85 °C
Storage Temperature Range : -40 ~ +85 °C
Power Capacity : 3W max.

Part Number

 AT
 3216
 B
 2R7
 HAA
 □
 /LF

 ①
 ②
 ③
 ④
 ⑤
 ⑥
 ⑦

① Туре	AT : Antenna	② Dimensions (L×W)	3.2× 1.6 mm
3 Material Code	В	4 Frequency Range	2R7=2700MHz
Specification Code	НАА	6 Packaging	T: Tape & Reel B: Bulk
Soldering	=lead-containing /LF=lead-free		

Terminal Configuration

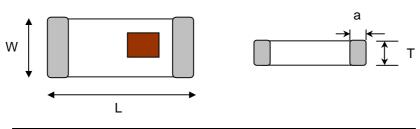


No.	Terminal Name	No.	Terminal Name		
1	Feeding Point	2	NC		



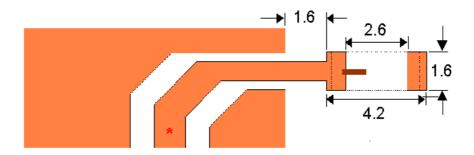
Dimensions and Recommended PC Board Pattern

Unit: mm

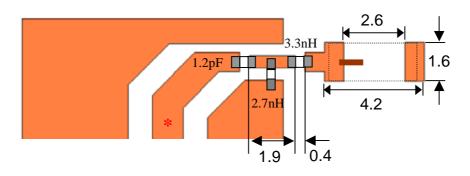


Mark	L	W	Т	а	
Dimensions	3.2±0.2	1.6±0.2	1.3+ 0.1/-0.2	0.5±0.3	

(a) Without Matching Circuits



(b) With Matching Circuits

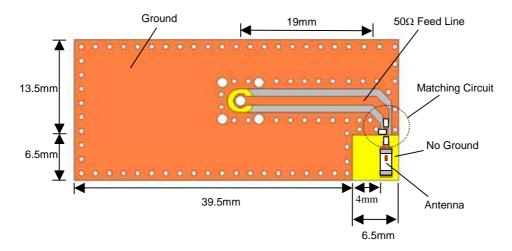


^{*}Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.



Typical Electrical Characteristics (T=25°C)

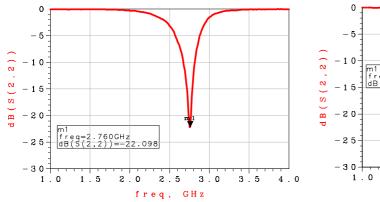
❖Test Board

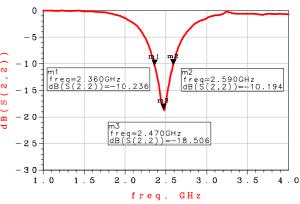


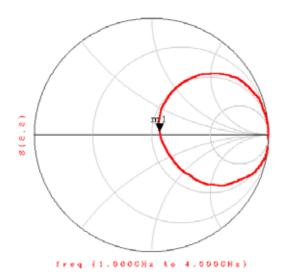
❖Return Loss

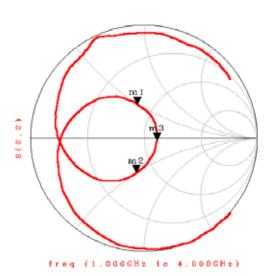
(a) Without Matching Circuits

(b) With Matching Circuits



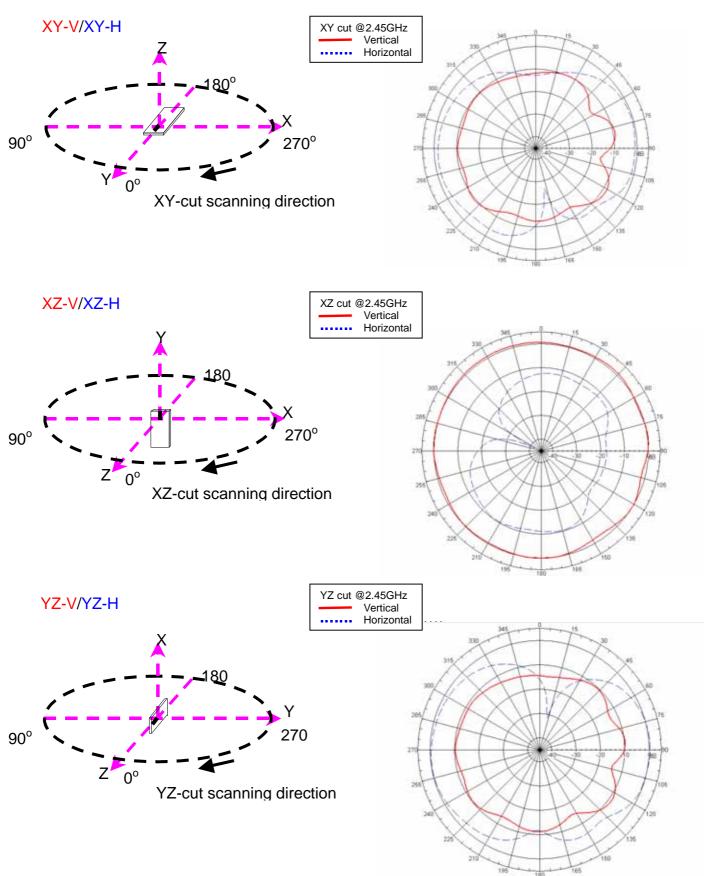








Radiation Patterns



Advanced Ceramic X Corp.

16 Tzu Chiang Road, Hsinchu Industrial District Hsinchu Hsien 303, Taiwan TEL:886-3-5987008 FAX:886-3-5987001

E-mail: acx@acxc.com.tw http://www.acxc.com.tw



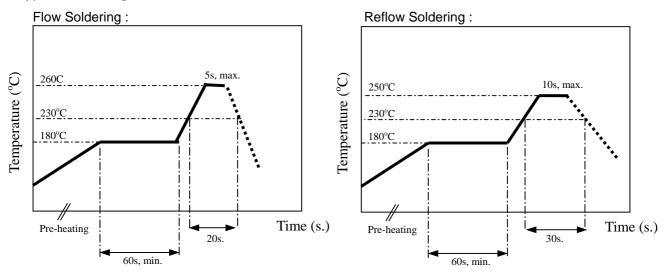
Mechanical & Environmental Characteristics

		Requirements		Procedure
Solderability	1. 2.	No apparent damage More than 75% of the terminal electrode shall be covered with new solder	1. 2.	Solder: 230± 5°C for 5± 1 sec
Thermal shock (Temperature Cycle)	1. 2.	No apparent damage Fulfill the electrical specification after test	1. 2. 3. 4.	One cycle/ step 1: 85 ± 5 °C for 20sec step 2: -40 ± 3 °C for 20sec Cycle time: 30min No. of cycles: 100 Recovery: 1-2hrs
Heat Resistance		No apparent damage Fulfill the electrical specification after test	1. 2. 3.	Temperature: 85± 2 °C Duration: 24±2hrs Recovery: 1-2hrs
Low Temperature Resistance	1. 2.	No apparent damage Fulfill the electrical specification after test	1. 2. 3.	
Humidity Resistance	1. 2.	No apparent damage Fulfill the electrical specification after test	1. 2. 3. 4.	Temperature: 85± 2°C Humidity: 80% ~ 85% RH Duration: 1000±48hrs Recovery: 1-2hrs
Soldering strength (Push strength)	1.	9.8N minimum	1. 2.	, , ,
Deflection (Bending)	1. 2.	No apparent damage Fulfill the electrical specification	,	Solder specimen onto test jig (FR4, 0.8mm) using the recommend soldering profile. Apply a bending force of 2mm deflection Pressure Rod R230 90mm
Drop Shock	1.	No apparent damage	1.	Dropped onto hard wood from height of 50 cm for 3 times; each x,y and z direction except terminal direction



Typical Soldering Profile

❖Typical Soldering Profile for Lead-free Process



The sample must be pre-heated before soldering .The temperature difference between preheating and soldering must be within 150 .

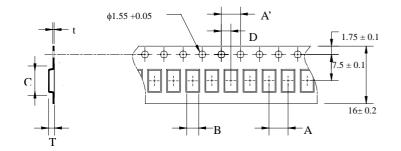
Notes

❖The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.



Taping Specifications

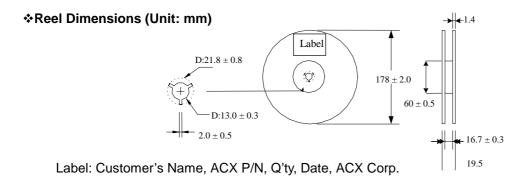
❖Tape Dimensions (Unit: mm)



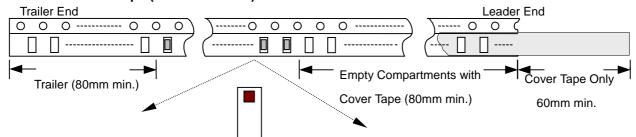
Туре	Α	A'	В	С	D	t	Т
3216	4.0±	4.0±	1.9±	3.5±	2.0±	0.20±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.4
5020	4.0±	4.0±	2.4±	5.5±	2.0±	0.20±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.4
7020	4.0±	4.0±	2.4±	7.3±	2.0±	0.22±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.55
7635	8.0±	4.0±	3.75±	7.85±	2.0±	0.30±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.40
8516	4.0±	4.0±	1.85±	8.70±	2.0±	0.25±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.40
9520	4.0±	4.0±	2.3±	9.7±	2.0±	0.22±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.45
R130	8.0±	4.0±	3.35±	10.35	2.0±	0.25±	Max.
	0.1	0.1	0.1	±0.1	0.1	0.05	1.40

❖Quantity

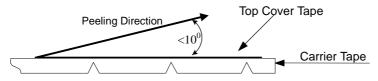
Туре	3216	5020	7020	7635	8516	9520	R130
Quantity	3,000pcs	2,000	1,000 pcs	1,000 pcs	1000pcs	1,000 pcs	1,000 pcs
/per reel	3,000pcs	2,000	1,000 pcs	1,000 pcs	Ισσορίο	1,000 μεδ	1,000 pcs



❖Leader and Trailer Tape (Plastic material)



❖Peel-off Force

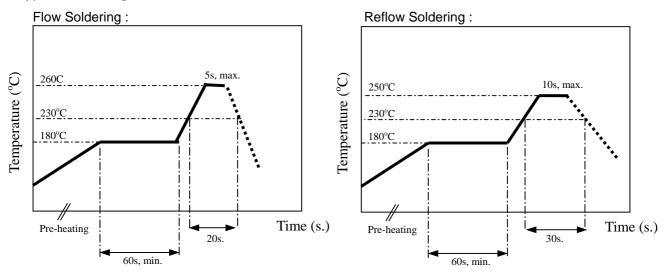


Peel-off force should be in the range of 0.1-0.6~N at a peel-off speed of $300\pm10~mm/min$.



Typical Soldering Profile

❖Typical Soldering Profile for Lead-free Process



The sample must be pre-heated before soldering .The temperature difference between preheating and soldering must be within 150 .

Notes

❖The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.

ACX

❖Storage Conditions

- (1) Temperature: 15 ~35 , relative humidity (RH): 45~75%.
- (2) Non-corrosive environment
- (3) Products should be used within six months of receipt.

Notes

❖The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.